

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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### 3-terminal Filters

For signal line

**MEM Series** 

# MEM2012SC Type

MEM2012SC 2012[0805 inch]\*

\* Dimensions Code JIS[EIA]

### REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

### SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

⚠ REMINDERS			
<ul> <li>The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity: 10 to 75 or less).</li> <li>If the storage period elapses, the soldering of the terminal electrodes may deteriorate.</li> </ul>	% RH		
On not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).			
<ul> <li>Before soldering, be sure to preheat components.</li> <li>The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.</li> </ul>	iture		
Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.			
When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip do the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.	ue to		
Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermodesign.	al		
Carefully lay out the coil for the circuit board design of the non-magnetic shield type.  A malfunction may occur due to magnetic interference.			
Use a wrist band to discharge static electricity in your body through the grounding wire.			
On not expose the products to magnets or magnetic fields.			
On not use for a purpose outside of the contents regulated in the delivery specifications.			
The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measureme equipment, industrial robots) under a normal operation and use condition.  The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage	or		
society, person or property.  If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or cond	ditions		

- (1) Aerospace/Aviation equipment
- $\hbox{(2) Transportation equipment (cars, electric trains, ships, etc.)}\\$
- (3) Medical equipment
- (4) Power-generation control equipment

set forth in the each catalog, please contact us.

- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.



### **3-terminal Filters**

### For signal line

Product compatible with RoHS directive
Halogen-free
Compatible with lead-free solders

# **Overview of MEM2012SC Type**

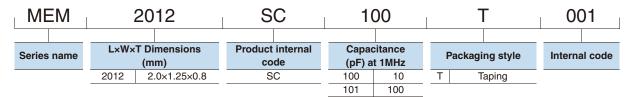
#### FEATURES

- Multilayer chip EMC filter.
- O Monolithic structure makes it highly reliable.
- Olosed magnetic circuit structure makes it possible to achieve high-density mounting without crosstalk.
- O Has sharp attenuation characteristics with excellent EMC suppression.
- Wide range of products compatible with passing frequencies and attenuating frequencies.
- T-type circuit is used.
- Ocompatible with 1A current.

#### APPLICATION

Noise removal from signal lines of data terminals, digital cameras, computers, game machines, flat TVs, etc.

#### PART NUMBER CONSTRUCTION



#### ■ OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

Temperature range		Package quantity	Individual weight	
Туре	Operating temperature	Storage temperature*		
	(°C)	(°C)	(pieces/reel)	(mg)
MEM2012SC	-40 to +85	-40 to +85	4,000	8

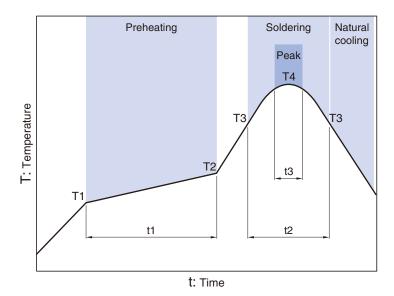
<sup>\*</sup> The Storage temperature range is for after the circuit board is mounted.

RoHS Directive Compliant Product: See the following for more details related to RoHS Directive compliant products. http://product.tdk.com/en/environment/rohs/

O Halogen-free: Indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.



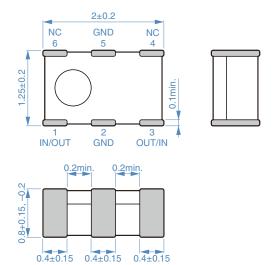
#### ■ RECOMMENDED REFLOW PROFILE



Soldering Preheating Peak Temp. Temp. Temp. Time Time Time T1 T2 T4 t3 Т3 150°C 180°C 60 to 120s 230°C 250 to 260°C 30 to 60s 10s max.



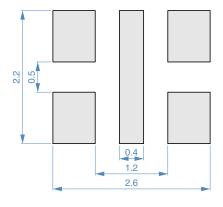
#### ■SHAPE & DIMENSIONS



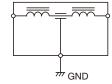


Dimensions in mm

#### ■ RECOMMENDED LAND PATTERN



#### **CIRCUIT DIAGRAM**



Dimensions in mm



#### **ELECTRICAL CHARACTERISTICS**

#### **CHARACTERISTICS SPECIFICATION TABLE**

Capacitance*	Tolerance	Rated voltage	Rated current	DC resistance	Part No.
				[Terminal No.1 to 3]	
(pF)	(%)	(V)max.	(A)max.	( $\Omega$ )max.	
10	±30	12	1	0.15	MEM2012SC100T001
22	±30	12	1	0.15	MEM2012SC220T001
47	±30	12	1	0.15	MEM2012SC470T001
100	±30	12	1	0.15	MEM2012SC101T001
150	±30	12	1	0.15	MEM2012SC151T001

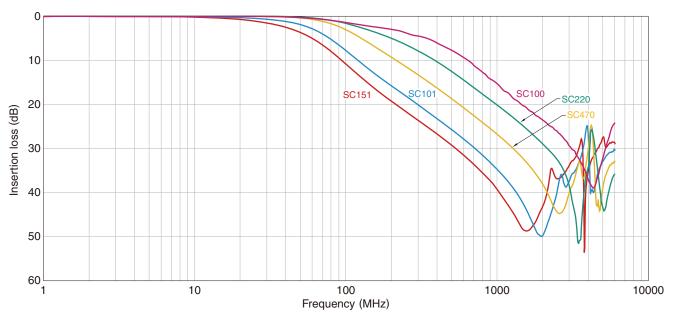
<sup>\*</sup> Measuring frequency: 1(MHz), measuring voltage: 1(V)

#### O Measurement equipment

Measurement item	Product No.	Manufacturer
Capacitance	4294A	Agilent Technologies
Frequency characteristics	N5230C	Agilent Technologies

<sup>\*</sup> Equivalent measurement equipment may be used.

#### ☐ INSERTION LOSS VS. FREQUENCY CHARACTERISTICS



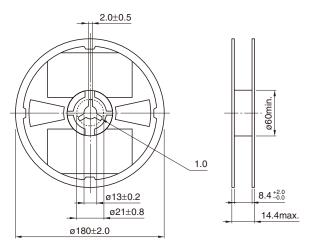
#### O Measurement equipment

Product No.	Manufacturer		
N5230C	Agilent Technologies		

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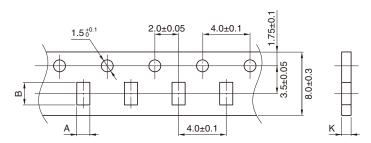
#### **■PACKAGING STYLE**

#### **□REEL DIMENSIONS**



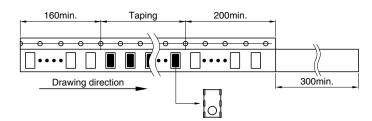
Dimensions in mm

#### **TAPE DIMENSIONS**



Dimensions in mm

Type	Α	В	K
MEM2012SC	1.55±0.20	2.30±0.20	1.10max.



Dimensions in mm